



ULN2002A/ ULN2003A/ ULN2004A

HIGH VOLTAGE, HIGH CURRENT DARLINGTON TRANSISTOR ARRAYS

Description

The ULN2002A, ULN2003A and ULN2004A are high voltage, high current Darlington arrays each containing seven open collector common emitter pairs. Each pair is rated at 500mA. Suppression diodes are included for inductive load driving, the inputs and outputs are pinned in opposition to simplify board layout.

Device options are designed to be compatible with common logic families:

ULN2002A (14-25V PMOS) ULN2003A (5V TTL, CMOS) ULN2004A (6-15V CMOS, PMOS)

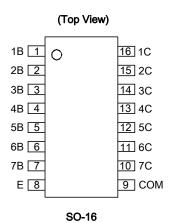
These devices are capable of driving a wide range of loads including solenoids, relays, DC motors, LED displays, filament lamps, thermal print-heads and high-power buffers.

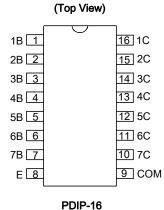
The ULN2002A, ULN2003A and ULN2004A are available in both a small outline 16-pin package (SO-16) and PDIP-16 package.

Features

- 500mA Rated Collector Current (Single Output)
- High Voltage Outputs: 50V
- Output Clamp Diodes
- Inputs Compatible with Popular Logic Types
- Relay Driver Applications
- "Green" Molding Compound (No Br, Sb)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Pin Assignments

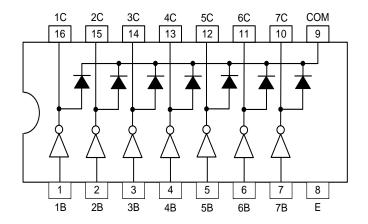




Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Connection Diagram

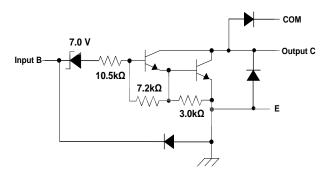




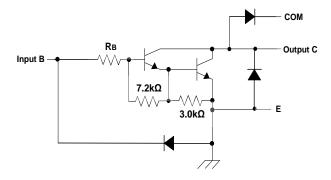
Pin Descriptions

Pin Number	Pin Name	Function	
SO-16/PDIP-16	Pin Name	Function	
1	1B	Input Pair 1	
2	2B	Input Pair 2	
3	3B	Input Pair 3	
4	4B	Input Pair 4	
5	5B	Input Pair 5	
6	6B	Input Pair 6	
7	7B	Input Pair 7	
8	E	Common Emitter (Ground)	
9	COM	Common Clamp Diodes	
10	7C	Output Pair 7	
11	6C	Output Pair 6	
12	5C	Output Pair 5	
13	4C	Output Pair 4	
14	3C	Output Pair 3	
15	2C	Output Pair 2	
16	1C	Output Pair 1	

Functional Block Diagram



ULN2002A



 $\begin{array}{ll} \text{ULN2003A:} & R_B = 2.7 k \\ \text{ULN2004A:} & R_B = 10.5 k \\ \end{array}$

ULN2003A, ULN2004A



Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter		Rating	Unit
Vcc	Collector to Emitter Voltage		50	V
V _R	Clamp Diode Reverse Voltage (Note 5)		50	V
VI	Input Voltage (Note 5)		30	V
I _{CP}	Peak Collector Current		500	mA
I _{OK}	Output Clamp Current	500	mA	
I _{TE}	Total Emitter Current		-2.5	Α
0	Thermal Resistance Junction-to-Ambient (Note 6)	SO-16	63.0	°C/W
θ _{JA}	Thermal Resistance Junction-to-Ambient (Note 6)	50.0	- C/VV	
Ο	Thermal Resistance Junction-to-Case (Note 7)	SO-16	12.0	°C/W
θ _{JC}	Thermal Resistance Junction-to-Case (Note 1)	15.0	C/VV	
TJ	Junction Temperature	+150	°C	
T _{STG}	Storage Temperature		-65 to +150	°C

Notes:

- 4. Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- 5. All voltage values are with respect to the emitter/substrate terminal E, unless otherwise noted.
- 6. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of +150°C can affect reliability.
- 7. Maximum power dissipation is a function of $T_J(max)$, θ_{JC} and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_C)/\theta_{JC}$. Operating at the absolute maximum T_J of +150°C can affect reliability.

Recommended Operating Conditions

Symbol Parameter		Min	Max	Unit
V _{CC} Collector to Emitter Voltage			50	V
T _A Operating Ambient Temperature		-40	+105	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

JLN2002A								
Symbol	Parameter	Test Figure	Test 0	Conditions	Min	Тур	Max	Unit
V _{I(ON)}	On State Input Voltage	6	$V_{CE} = 2V, I_{C} = 3$	B00mA	_	_	13	V
			$I_1 = 250 \mu A, I_C =$	100mA	_	0.9	1.1	
$V_{CE(SAT)}$	Collector Emitter Saturation Voltage	5	$I_1 = 350 \mu A, I_C =$	200mA	_	1	1.3	V
	Voltage		$I_1 = 500 \mu A, I_C =$	350mA	_	1.2	1.6	
V _F	Clamp Forward Voltage	8	I _F = 350mA		_	1.7	2	V
	Collector Cut-off Current	1	$V_{CE} = 50V, I_{I} = 0$	0	_	_	50	
I _{CEX}		2	V _{CE} = 50V,	$I_1 = 0$	_	_	100	μΑ
			$T_A = +105^{\circ}C$	V _I = 6V	_	_	500	
I _{I(OFF)}	Off State Input Current	3	V _{CE} = 50V, I _C =	500µA	50	65	_	μΑ
lı	Input Current	4	V _I = 17V		_	0.82	1.25	mA
1-	Clamp Boyorgo Current	7	V- FOV	T _A = +105°C	_	_	100	
I _R	Clamp Reverse Current		$V_R = 50V$	_	_	_	50	μA
Cı	Input Capacitance	_	$V_1 = 0$, $f = 1MHz$	<u> </u>	_	_	25	pF



Electrical Characteristics (Cont.) (@T_A = +25°C, unless otherwise specified.)

ULN2003								1
	Parameter	Test Figure	Test	Conditions	Min	Тур	Max	Unit
				$I_C = 200 \text{mA}$	_	_	2.4	
$V_{I(ON)}$	On State Input Voltage	6	$V_{CE} = 2V$	$I_C = 250 \text{mA}$	_	_	2.7	V
				$I_C = 300 \text{mA}$	_	_	3	
	Oallandar Freittan Oatsmatian		$I_1 = 250 \mu A, I_C$	= 100mA	1	0.9	1.1	
$V_{CE(SAT)}$	Collector Emitter Saturation Voltage	5	$I_1 = 350 \mu A, I_C =$	= 200mA		1	1.3	V
	Vollage		$I_1 = 500 \mu A, I_C =$	= 350mA	_	1.2	1.6	
VF	Clamp Forward Voltage	8	I _F = 350mA			1.7	2	V
		1	V _{CE} = 50V, I _I =	: 0		_	50	
I _{CEX}	Collector Cut-off Current	2	$V_{CE} = 50V,$ $T_A = +105^{\circ}C$	$I_1 = 0$	_	_	100	μA
I _{I(OFF)}	Off State Input Current	3	V _{CE} = 50V, I _C =	= 500µA	50	65	_	μA
I _I	Input Current	4	V _I = 3.85V	-	_	0.93	1.35	mA
		7		T _A = +105°C	_	_	100	μA
I _R Clamp	Clamp Reverse Current			_		_	50	
Cı	Input Capacitance	_	$V_1 = 0, f = 1MF$	łz	_	15	25	pF
JLN2004	4		1					
	Parameter	Test Figure	Test	Conditions	Min	Тур	Max	Uni
		6	V _{CE} = 2V	$I_C = 125mA$		_	5	
				$I_C = 200 \text{mA}$	_	_	6	
$V_{I(ON)}$	On State Input Voltage			I _C = 275mA		_	7	
				I _C = 350mA		_	8	
			I _I = 250μA, I _C = 100mA			0.9	1.1	
V _{CE(SAT)}	Collector Emitter Saturation Voltage	5	I _I = 350μA, I _C =	200mA		1	1.3	V
- (- /	Voltage		I _I = 500μA, I _C = 350mA		_	1.2	1.6	1
V _F	Clamp Forward Voltage	8	I _F = 350mA			1.7	2	V
•	<u> </u>	1	$V_{CE} = 50V, I_{I} = 0$)		_	50	
ICEX	Collector Cut-off Current			lı = 0		_	100	μA
ICEX		2	$V_{CE} = 50V, T_A =$	+105°C V _I = 6V		_	500	- "
	Off State Input Current	3	V _{CE} = 50V, I _C =		50	65	_	μΑ
II(OFF)	IOII State IIIbut Cullelit	1 -				0.35	0.5	mA
I _{I(OFF)}	' '	4	$V_1 = 5V$		_	0.55		
I _{I(OFF)}	Input Current	4	V _I = 5V	T _A = +105°C				1117
. ,	' '	7	$V_I = 5V$ $V_R = 50V$	T _A = +105°C		— —	100	μA



Electrical Characteristics (Cont.) ($@T_A = -40^{\circ}C$ to $+105^{\circ}C$, unless otherwise specified.)

ULN2003/	JLN2003A								
	Parameter	Test Figure	Test Conditions		Min	Тур	Max	Unit	
				$I_{C} = 200 \text{mA}$	_	_	2.7		
$V_{I(ON)}$	On State Input Voltage	6	$V_{CE} = 2V$	$I_C = 250mA$	_	_	2.9	V	
				$I_{C} = 300 \text{mA}$	_	_	3		
			$I_{I} = 250 \mu A, I_{C}$	= 100mA	_	0.9	1.2		
V _{CE(SAT)}	Collector Emitter Saturation Voltage	5	$I_1 = 350\mu A, I_C = 200mA$		_	1	1.4	V	
			$I_I = 500\mu A, I_C = 350mA$		_	1.2	1.7		
V _F	Clamp Forward Voltage	8	I _F = 350mA	$I_F = 350 \text{mA}$		1.7	2.2	V	
ICEX	Collector Cut-off Current	1	V _{CE} = 50V, I _I =	= 0	_	_	100	μΑ	
I _{I(OFF)}	Off State Input Current	3	V _{CE} = 50V, I _C	$V_{CE} = 50V, I_C = 500\mu A$		65	_	μΑ	
l _l	Input Current	4	V _I = 3.85V		_	0.93	1.35	mA	
I _R	Clamp Reverse Current	7	V _R = 50V		_	_	100	μA	
Cı	Input Capacitance	_	$V_{I} = 0$, $f = 1MI$	-lz	_	15	25	pF	

Switching Characteristics (@T_A = +25°C, unless otherwise specified.)

ULN2002A, ULN2003A, ULN2004A								
Parameter		Test figure	Min	Тур	Max	Unit		
t _{PLH}	Propagation Delay Time, Low to High Level Output	9	_	0.25	1	μs		
t _{PHL}	Propagation Delay Time, High to Low Level Output	9	_	0.25	1	μs		
VoH	High Level Output Voltage after Switching	9 ($V_S = 50V$, $I_O = 300mA$)	V _S -20		1	mV		

Switching Characteristics (@T_A = -40 to +105°C, unless otherwise specified.)

ULN2003A								
Parameter		Test figure	Min	Тур	Max	Unit		
t _{PLH}	Propagation Delay Time, Low to High Level Output	9	_	1	10	μs		
t _{PHL}	Propagation Delay Time, High to Low Level Output	9	_	1	10	μs		
V _{OH}	High Level Output Voltage after Switching	9 ($V_S = 50V$, $I_O = 300mA$)	V _S -50	_	_	mV		



Parameter Measurement Circuits

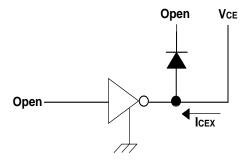


Fig.1 ICEX Test Circuit

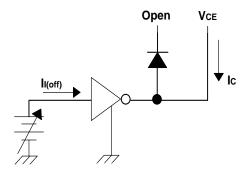


Fig.3 II(off) Test Circuit

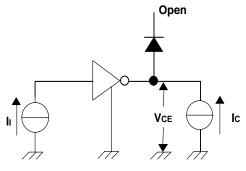


Fig. 5 hfe, VCE(sat) Test Circuit

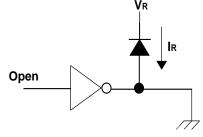


Fig. 7 IR Test Circuit

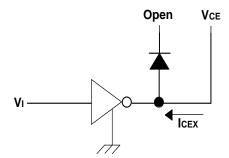


Fig.2 ICEX Test Circuit

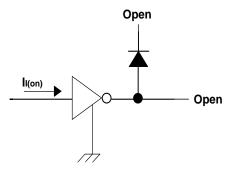


Fig.4 In Test Circuit

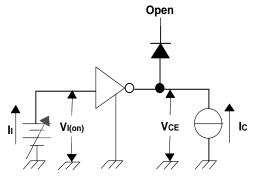


Fig. 6 VI(on) Test Circuit

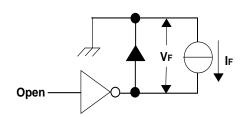


Fig. 8 VF Test Circuit



Parameter Measurement Circuits (Cont.)

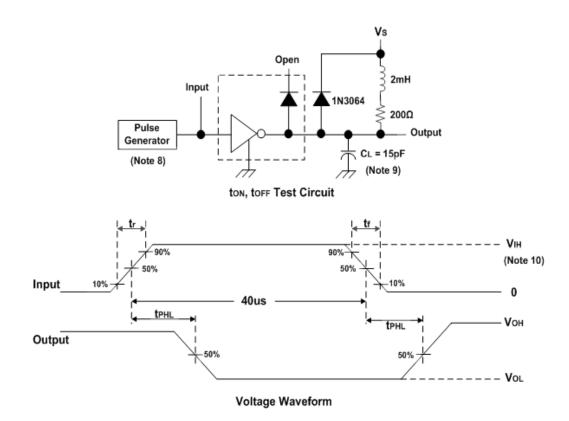


Fig. 9 Latch-Up Test Circuit and Voltage Waveform

Notes: 8. The pulse generator has the following characteristics: Pulse Width = 12.5Hz, output impedance 50Ω , tr ≤ 5 ns, tr ≤ 10 ns.

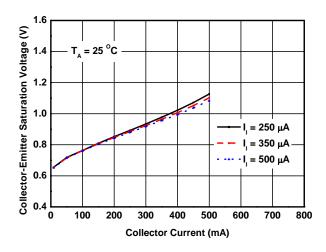
9. C_L includes prove and jig capacitance.

10. For testing the ULN2002A, $V_{IH} = 13V$; for the ULN2003A, $V_{IH} = 3V$; for the ULN2004A, $V_{IH} = 8V$.

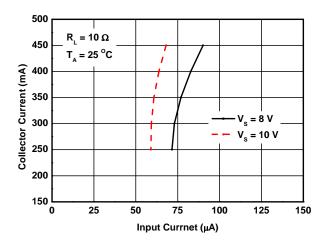


Typical Performance Characteristics

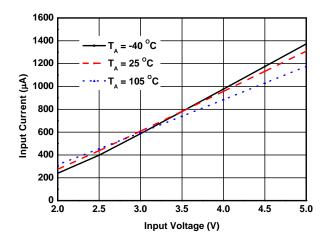
Collector-Emitter Saturation Voltage vs. Collector Current (One Darlington)



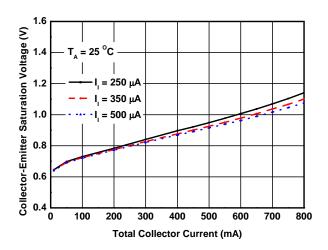
Collector Current vs. Input Current



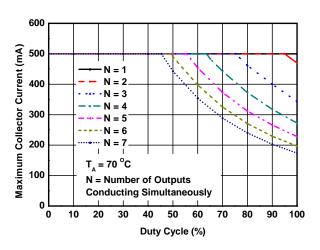
Input Current vs. Input Voltage



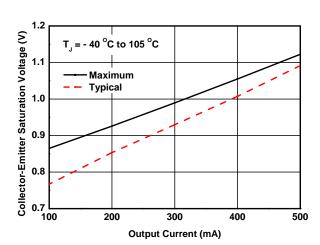
Collector-Emitter Saturation Voltage vs. Collector Current (Two Darlington in Parallel)



Maximum Collector Current vs. Duty Cycle



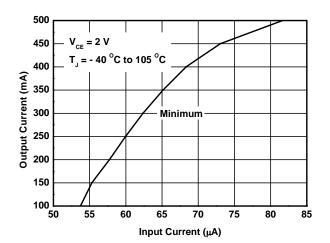
Collector-Emitter Saturation Voltage vs.
Output Current





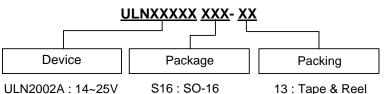
Typical Performance Characteristics (Cont.)

Output Current vs. Input Current





Ordering Information



ULN2002A: 14~25V ULN2003A: 5V TTL

D16: PDIP-16

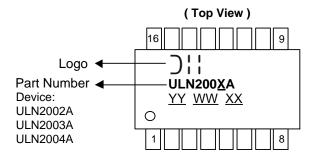
13 : Tape & Reel U : Tube

ULN2004A: 6~15V

	Paakaga		13" Tape an	d Reel	Т	ube
Part Number	Package Code	Package	Quantity	Part Number Suffix	Quantity	Part Number Suffix
ULN2002AS16-13	S16	SO-16	2,500/Tape & Reel	-13	NA	NA
ULN2003AS16-13	S16	SO-16	2,500/Tape & Reel	-13	NA	NA
ULN2004AS16-13	S16	SO-16	2,500/Tape & Reel	-13	NA	NA
ULN2002AD16-U	D16	PDIP-16	NA	NA	25/Tube	-U
ULN2003AD16-U	D16	PDIP-16	NA	NA	25/Tube	-U
ULN2004AD16-U	D16	PDIP-16	NA	NA	25/Tube	-U

Marking Information

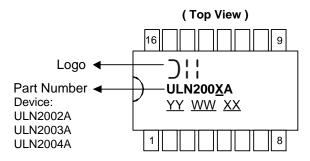
(1) SO-16



<u>YY</u>: Year: 08, 09,10~ <u>WW</u>: Week: 01~52; 52 represents 52 and 53 week

XX: Internal Code

(2) PDIP-16



YY: Year: 08, 09,10~ WW: Week: 01~52; 52 represents 52 and 53 week

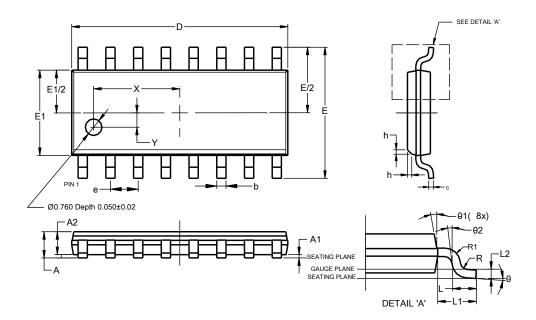
XX : Internal Code



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

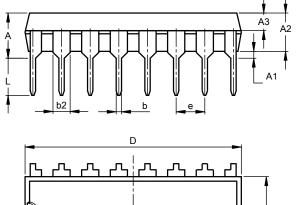
(1) Package Type: SO-16

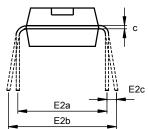


E1

SO-16							
Dim	Min	Max	Тур				
Α	-	1.260					
A1	0.10	0.23					
A2	1.02						
b	0.31	0.51					
C	0.10	0.25					
D	9.80	10.00					
Е	5.90	6.10					
E1	3.80	4.00					
е	1	.27 BS	0				
h	0.15	0.25	0.20				
٦	0.40	1.27					
L1	1	.04 RE	F				
L2	C).25 BS()				
R	0.07						
R1	0.07						
X	3.	945 RE	F				
Y		.661 RE	F				
θ	0°	8°					
θ1	5°	15°					
θ2	0°						
All	Dimens	ions in	mm				

(2) Package Type: PDIP-16





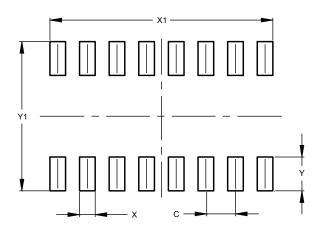
PDIP-16							
Dim	Min	Max	Nom				
Α	3.60	4.00	3.80				
A1	0.51	-	-				
A2	3.20	3.40	3.30				
A3	1.47	1.57	1.52				
b	0.44	0.53	-				
b2	•	1.52BSC					
C	0.25	0.31	-				
D	18.90	19.30	19.10				
E1	6.15	6.55	6.35				
E2a	7	7.62 BS0					
E2b	7.62	9.30	-				
E2c	0.00	0.84	-				
е	- 2	2.54BSC)				
L	3.00	-	-				
All	Dimens	ions in	mm				



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SO-16



Dimensions	Value (in mm)
С	1.270
X	0.670
X1	9.560
Y	1.450
Y1	6.400





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